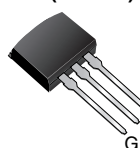
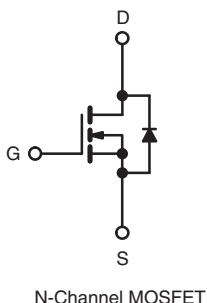
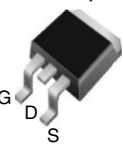


Power MOSFET

PRODUCT SUMMARY

V_{DS} (V)	60	
$R_{DS(on)}$ (Ω)	$V_{GS} = 5\text{ V}$	0.20
Q_g (Max.) (nC)	8.4	
Q_{gs} (nC)	3.5	
Q_{gd} (nC)	6.0	
Configuration	Single	

I²PAK (TO-262)

D²PAK (TO-263)


FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Advanced Process Technology
- Surface Mount (IRLZ14S, SiHLZ14S)
- Low-Profile Through-Hole (IRLZ14L, SiHLZ14L)
- 175 °C Operating Temperature
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC



RoHS*
COMPLIANT
HALOGEN
FREE
Available

DESCRIPTION

Third generation Power MOSFETs from Vishay utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that Power MOSFETs are well known for, provides the designer with an extremely efficient reliable device for use in a wide variety of applications.

The D²PAK is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and lowest possible on-resistance in any existing surface mount package. The D²PAK is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

The through-hole version (IRLZ44L, SiHLZ44L) is available for low-profile applications.

ORDERING INFORMATION

Package	D ² PAK (TO-263)	D ² PAK (TO-263)	D ² PAK (TO-263)	I ² PAK (TO-262)
Lead (Pb)-free and Halogen-free	SiHLZ14S-GE3	SiHLZ14STRL-GE3 ^a	SiHLZ14STRR-GE3 ^a	-
Lead (Pb)-free	IRLZ14SPbF	-	IRLZ14STRRPbF ^a	IRLZ14LPbF
	SiHLZ14S-E3	-	SiHLZ14STR-E3	SiHLZ14L-E3

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS ($T_C = 25\text{ °C}$, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage ^e	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 10	
Continuous Drain Current	V_{GS} at 5 V	$T_C = 25\text{ °C}$	A
		$T_C = 100\text{ °C}$	
Pulsed Drain Current ^{a, e}	I_{DM}	40	
Linear Derating Factor		0.29	W/°C
Single Pulse Avalanche Energy ^{b, e}	E_{AS}	68	mJ
Maximum Power Dissipation		$T_C = 25\text{ °C}$	W
		$T_A = 25\text{ °C}$	
Peak Diode Recovery dV/dt ^{c, e}	dV/dt	4.5	V/ns
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to + 175	°C
Soldering Recommendations (Peak Temperature)	for 10 s	300 ^d	

Notes

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- $V_{DD} = 25\text{ V}$, starting $T_J = 25\text{ °C}$, $L = 790\text{ }\mu\text{H}$, $R_g = 25\text{ }\Omega$, $I_{AS} = 10\text{ A}$ (see fig. 12).
- $I_{SD} \leq 10\text{ A}$, $dI/dt \leq 90\text{ A}/\mu\text{s}$, $V_{DD} \leq V_{DS}$, $T_J \leq 175\text{ °C}$.
- 1.6 mm from case.
- Uses IRLZ14, SiHLZ14 data and test conditions.

* Pb containing terminations are not RoHS compliant, exemptions may apply

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient (PCB Mount) ^a	R_{thJA}	-	40	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	3.5	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)								
PARAMETER		SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static								
Drain-Source Breakdown Voltage		V _{DS}	V _{GS} = 0, I _D = 250 μA		60	-	-	V
V _{DS} Temperature Coefficient		ΔV _{DS} /T _J	Reference to 25 °C, I _D = 1 mA		-	0.07	-	V/°C
Gate-Source Threshold Voltage		V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA		1.0	-	2.0	V
Gate-Source Leakage		I _{GSS}	V _{GS} = ± 10 V		-	-	± 100	nA
Zero Gate Voltage Drain Current		I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V		-	-	25	μA
			V _{DS} = 48 V, V _{GS} = 0 V, T _J = 150 °C		-	-	250	
Drain-Source On-State Resistance		R _{DS(on)}	V _{GS} = 5 V	I _D = 6.0 A ^b	-	-	0.2	Ω
			V _{GS} = 4 V	I _D = 5.0 A ^b	-	-	0.28	
Forward Transconductance		g _{fs}	V _{DS} = 25 V, I _D = 6.0 A		3.5	-	-	S
Dynamic								
Input Capacitance		C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1.0 MHz, see fig. 5		-	400	-	pF
Output Capacitance		C _{oss}			-	170	-	
Reverse Transfer Capacitance		C _{rss}			-	42	-	
Total Gate Charge		Q _g	V _{GS} = 5 V	I _D = 10 A, V _{DS} = 48 V, see fig. 6 and 13 ^b	-	-	8.4	nC
Gate-Source Charge		Q _{gs}			-	-	3.5	
Gate-Drain Charge		Q _{gd}			-	-	6.0	
Turn-On Delay Time		t _{d(on)}	V _{DD} = 30 V, I _D = 10 A, R _g = 12 Ω, R _D = 2.8 Ω, see fig. 10 ^b		-	9.3	-	ns
Rise Time		t _r			-	110	-	
Turn-Off Delay Time		t _{d(off)}			-	17	-	
Fall Time		t _f			-	26	-	
Internal Source Inductance		L _S	Between lead, and center of die contact		-	7.5	-	nH
Drain-Source Body Diode Characteristics								
Continuous Source-Drain Diode Current		I _S	MOSFET symbol showing the integral reverse p - n junction diode 		-	-	10	A
Pulsed Diode Forward Current ^a		I _{SM}			-	-	40	
Body Diode Voltage		V _{SD}	T _J = 25 °C, I _S = 10 A, V _{GS} = 0 V ^b		-	-	1.6	V
Body Diode Reverse Recovery Time		t _{rr}	T _J = 25 °C, I _F = 10 A, dI/dt = 100 A/μs ^b		-	93	130	ns
Body Diode Reverse Recovery Charge		Q _{rr}			-	340	650	nC
Forward Turn-On Time		t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)					

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. Pulse width $\leq 300\text{ }\mu\text{s}$; duty cycle $\leq 2\%$.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

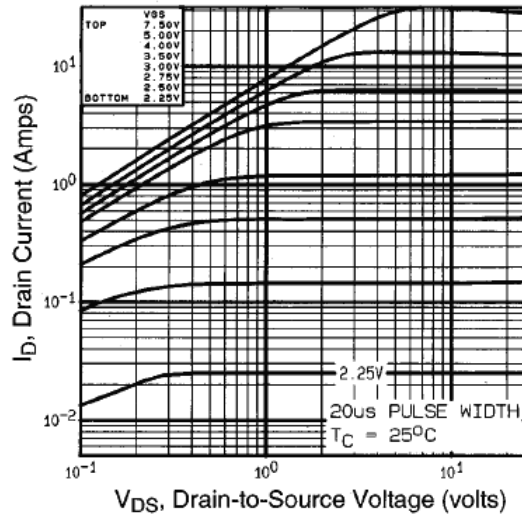


Fig. 1 - Typical Output Characteristics

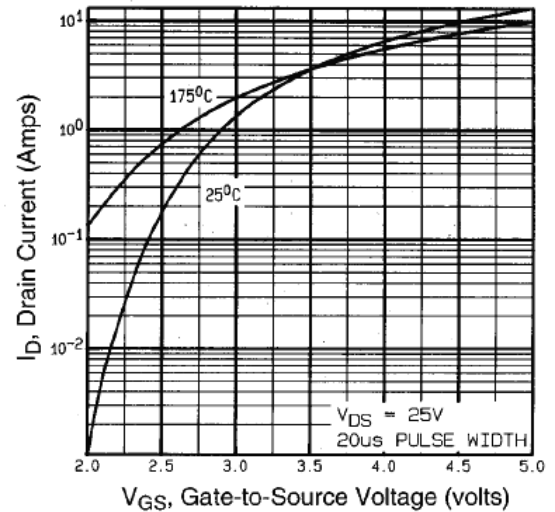


Fig. 3 - Typical Transfer Characteristics

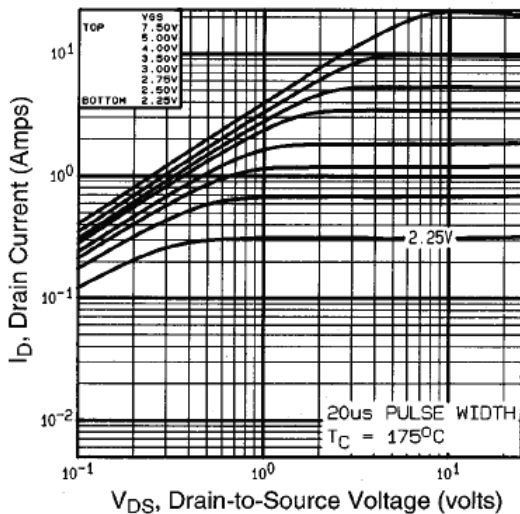


Fig. 2 - Typical Output Characteristics

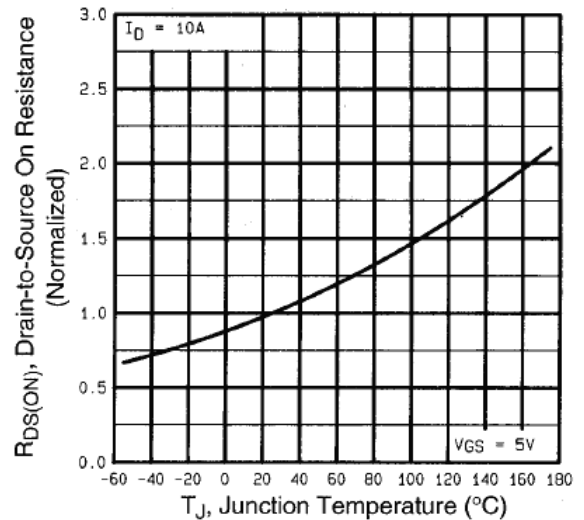


Fig. 4 - Normalized On-Resistance vs. Temperature

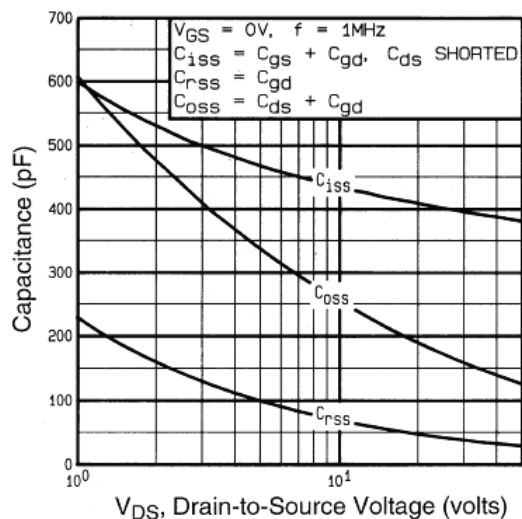


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

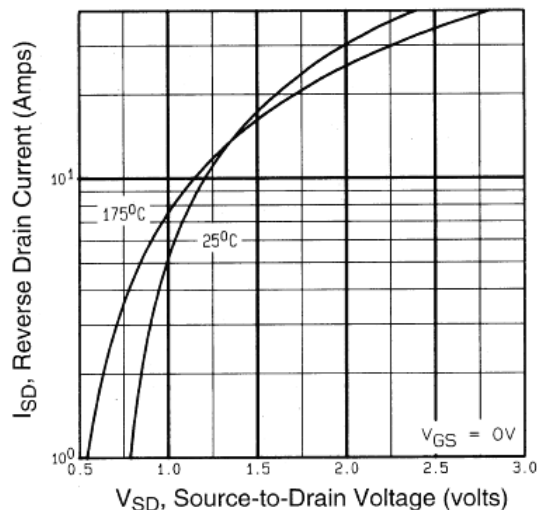


Fig. 7 - Typical Source-Drain Diode Forward Voltage

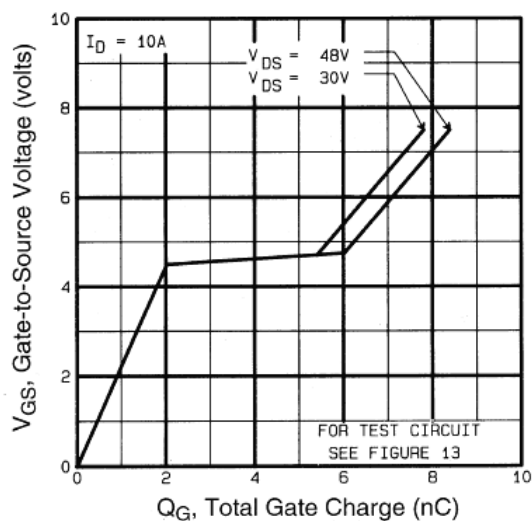


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

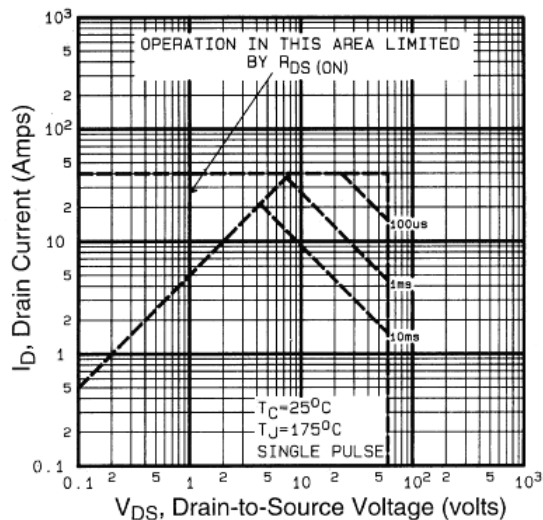


Fig. 8 - Maximum Safe Operating Area

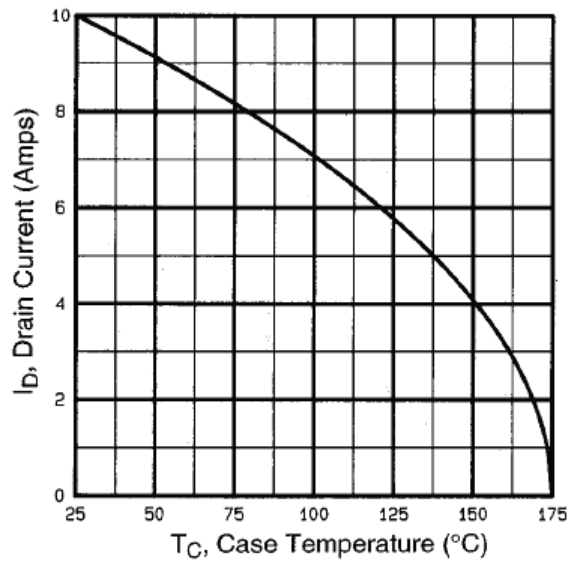


Fig. 9 - Maximum Drain Current vs. Case Temperature

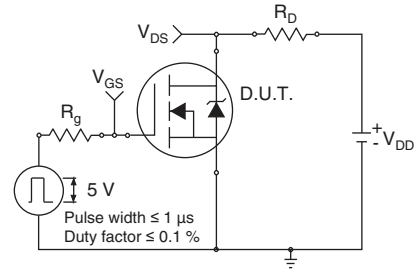


Fig. 10a - Switching Time Test Circuit

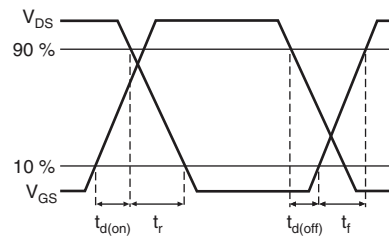


Fig. 10b - Switching Time Waveforms

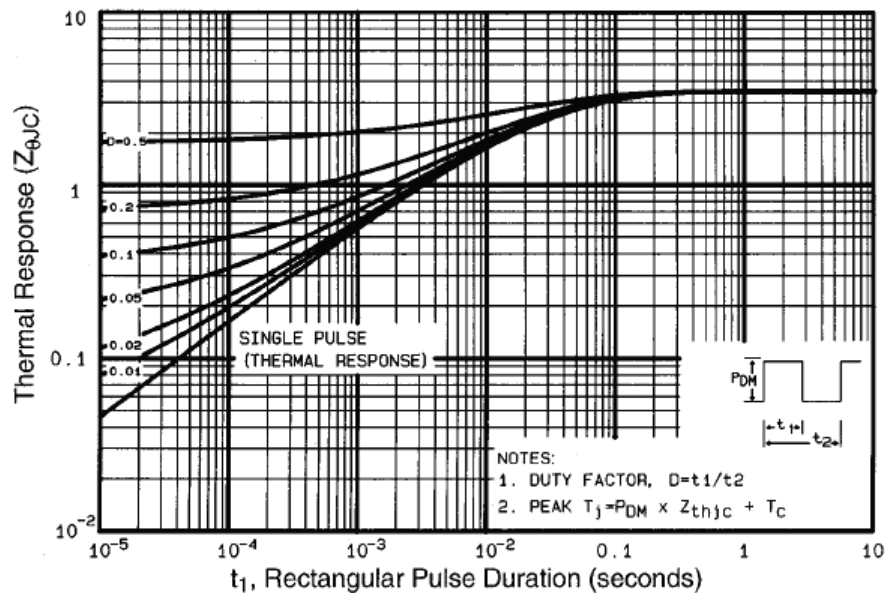


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

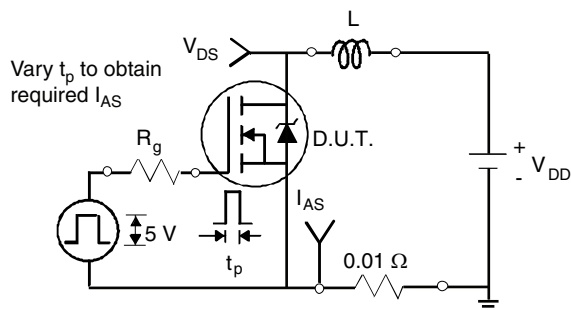


Fig. 12a - Unclamped Inductive Test Circuit

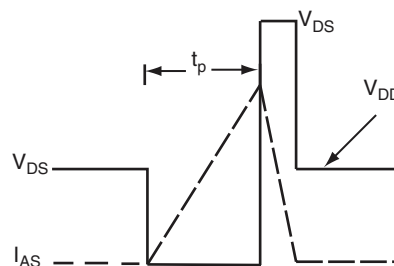


Fig. 12b - Unclamped Inductive Waveforms

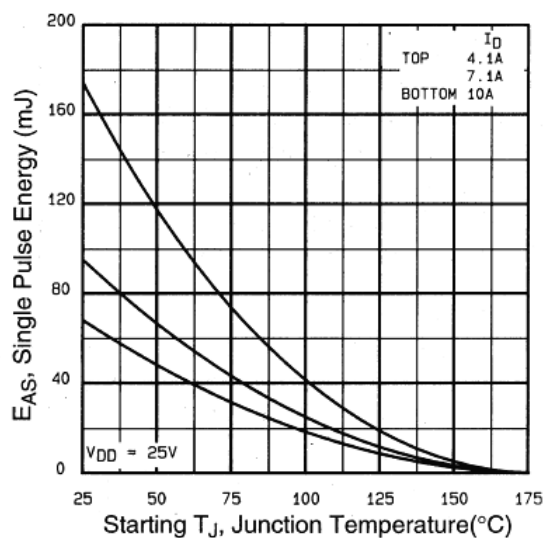


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

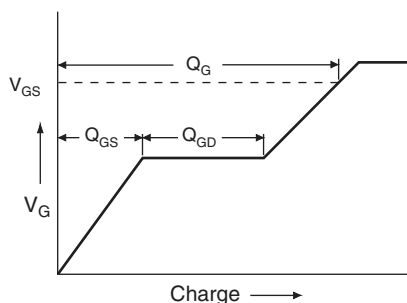


Fig. 13a - Basic Gate Charge Waveform

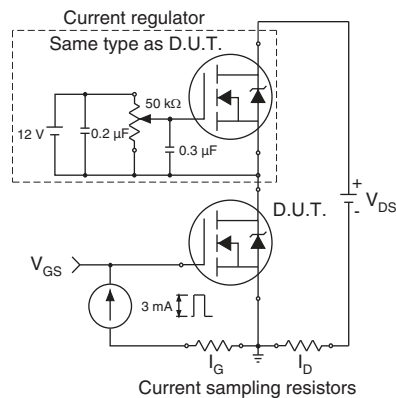
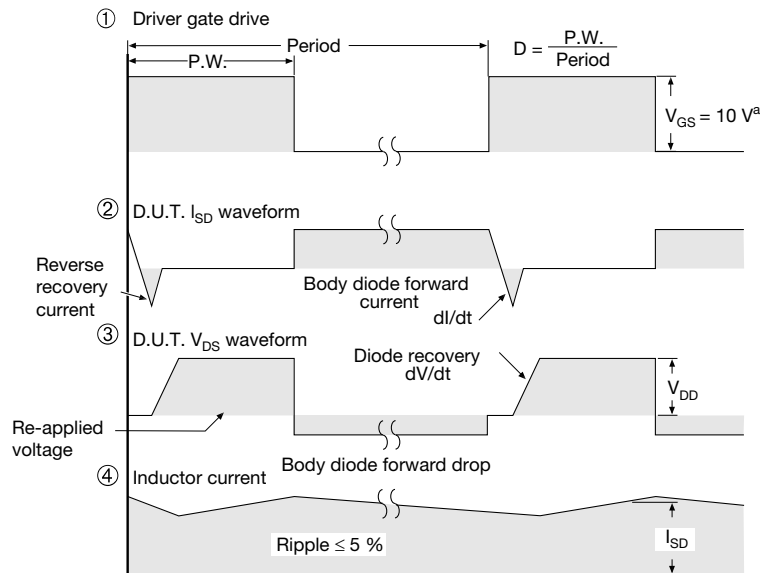
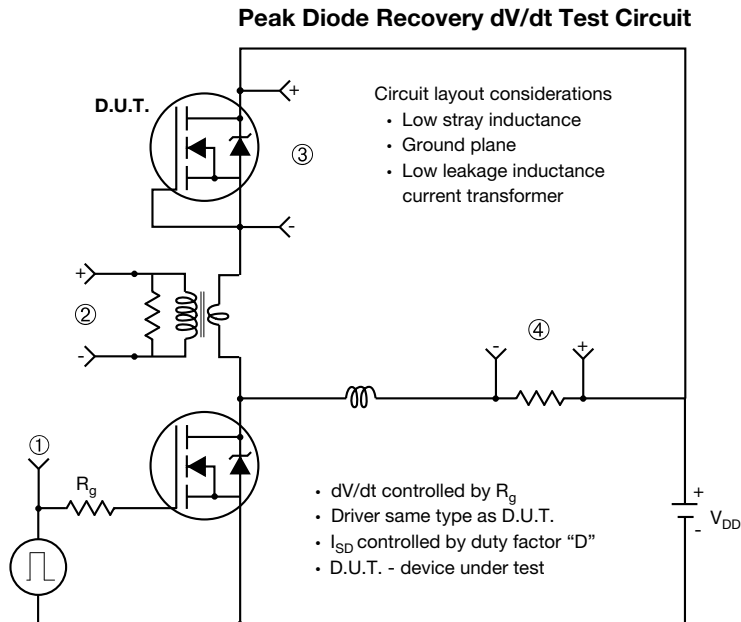


Fig. 13b - Gate Charge Test Circuit



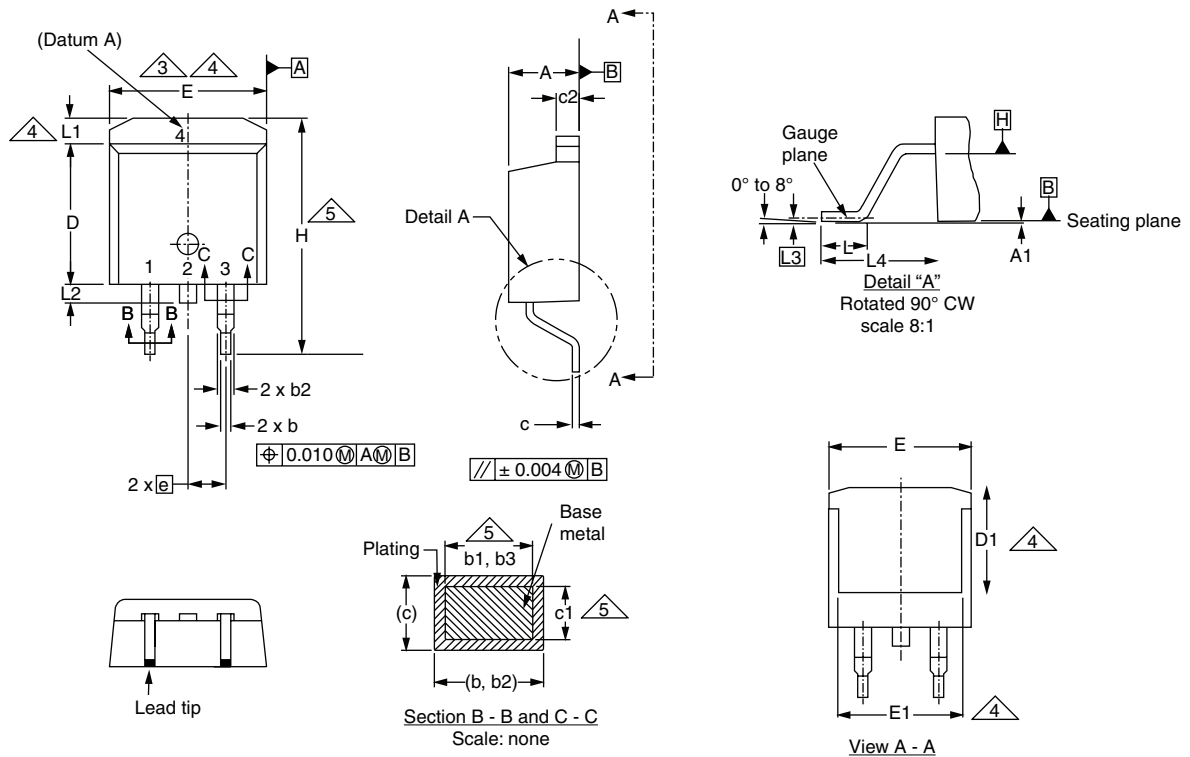
Note

a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?90414.

TO-263AB (HIGH VOLTAGE)



DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
c	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
D1	6.86	-	0.270	-
E	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	-
e	2.54 BSC		0.100 BSC	
H	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	-	1.65	-	0.066
L2	-	1.78	-	0.070
L3	0.25 BSC		0.010 BSC	
L4	4.78	5.28	0.188	0.208

ECN: S-82110-Rev. A, 15-Sep-08
DWG: 5970

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.
2. Dimensions are shown in millimeters (inches).
3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
5. Dimension b1 and c1 apply to base metal only.
6. Datum A and B to be determined at datum plane H.
7. Outline conforms to JEDEC outline to TO-263AB.



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